

Product Disposal Instructions

Producer's Name :	<u>GUANGDONG OPPO MOBILE TELECOMMUNICATIONS CORP., LTD.</u>
Producer's Address :	<u>NO.18 HAIBIN ROAD, WUSHA VILLAGE, CHANG'AN TOWN,</u> <u>DONGGUAN CITY, GUANGDONG, CHINA</u>

According to Directive 2012/19/EU, to assess the reuse, recycle and recovery, the product complied with the requirement of WEEE as follows:

Product information

Product Model	CPH2825
Product Size	158.00mm×74.83mm×7.89mm
Category under the WEEE Directive	6 th category (Small IT and telecommunications equipment)

Selective Treatment for Materials and Components

According to Articles 8(2) and the Annex VII of the WEEE Directive, this product contains components and material items are described in the following table.

Component/Material	Size	Quantity	Weight (g)
Printed circuit boards of mobile phones generally, and of other devices if the surface of the printed circuit board is greater than 10 square centimeters	17.91 cm ²	1	11.2
	24.50 cm ²	1	70.7
	24.50 cm ²	1	71.7
Battery	/	1	81.8
liquid crystal displays (together with their casing where appropriate) of a surface greater than 100 square Centimeters and all those back-lighted with gas discharge lamps	112.3 cm ²	1	24.0

Disassembly Procedure

The disassembly procedure taken here is in accordance with the treatment requirements under the Annex VII of the WEEE Directive. In addition, to consider economic and efficiency factors, manual operation and disassembly tools have been applied to separate the components and materials from this product in order to simulate the scenario at the treatment facility, and to achieve the objective that the separated components and materials can be reused, recycled and recovered.

Disassembly Tool

The disassembly tools used for this product are heater, alcohol, tweezers, ejection pin, disassemble rod, suction cup, screwdriver.

Material and Recycling Information

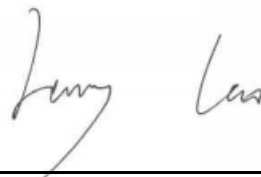
The reuse, recycling and recovery assessment for this product is based upon economic and efficiency considerations, and the waste treatment technologies and equipment that are most frequently available to the market.

Component/Material Composition	Weight(g)	Percent Weight(%)	Reuse/Recycling Rate(%)	Energy Recovery Rate(%)	Recovery Rate(%)
Display part	24.0	8.90	7.83	0.45	8.28
Back plate part	21.3	7.90	6.95	0.40	7.35
Metal case part	37.6	13.95	13.25	0.00	13.25
Assembly unit	10.4	3.86	3.39	0.19	3.59
Protection plate	4.5	1.67	1.47	0.08	1.55
FPC unit	2.1	0.78	0.70	0.00	0.70
Plastic film part	1.7	0.63	0.51	0.06	0.57
PCB unit	1.9	0.70	0.63	0.00	0.63
PCB unit	11.2	4.15	3.74	0.00	3.74
Card slot	0.3	0.11	0.10	0.01	0.10
Wire part	0.3	0.11	0.09	0.01	0.10
Screw part	0.7	0.26	0.25	0.00	0.25
White cable part	41.6	15.43	12.50	1.54	14.04
Plastic case	34.1	12.65	10.25	1.26	11.51
Metal pin	4.9	1.82	1.73	0.00	1.73
Wire part	0.3	0.11	0.09	0.01	0.10
PCB unit	70.7	26.22	23.60	0.00	23.60
Total	267.6	99.26	87.08	4.02	91.10

Component/Material Composition	Weight(g)	Percent Weight(%)	Reuse/Recycling Rate(%)	Energy Recovery Rate(%)	Recovery Rate(%)
Display part	24.0	8.57	7.55	0.43	7.97
Back plate part	21.3	7.61	6.70	0.38	7.08
Metal case part	37.6	13.43	12.76	0.00	12.76
Assembly unit	10.4	3.72	3.27	0.19	3.46
Protection plate	4.5	1.61	1.41	0.08	1.50
FPC unit	2.1	0.75	0.68	0.00	0.68
Plastic film part	1.7	0.61	0.49	0.06	0.55
PCB unit	1.9	0.68	0.61	0.00	0.61
PCB unit	11.2	4.00	3.60	0.00	3.60
Card slot	0.3	0.11	0.09	0.01	0.10
Wire part	0.3	0.11	0.09	0.01	0.10
Screw part	0.7	0.25	0.24	0.00	0.24
White cable part	41.6	14.86	12.04	1.49	13.52
Plastic case	41.4	14.79	11.98	1.48	13.46
Metal pin	6.9	2.47	2.34	0.00	2.34
Wire part	0.3	0.11	0.09	0.01	0.10
PCB unit	71.7	25.62	23.05	0.00	23.05
Total	277.9	99.29	86.99	4.13	91.12

Name, Surname : Jerry, lao

Position/Title : Compliance Manager



2025.12.04

(Date)

(legal signature)